



Pulp and Paper Industries Committee James A. Rooks Memorial Student Intern Program

One of the challenges the Pulp and Paper Industry faces going forward is attracting and retaining new, young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industrial Applications Society (IAS) to sponsor up to four Co-op/Intern Students to their upcoming Annual Conference.

The reason is simple – the more they can learn about the industry and what it has to offer, the more likely they will be to consider joining the industry after graduation. This is also a great way to meet other industry engineers, learn solutions to real mill needs, and network with senior professionals from the industry.

What is included?

- ✓ Airfare/Mileage
- ✓ Hotel
- ✓ Conference Registration
- ✓ One Tutorial

- ✓ Conference Reception
- ✓ Vendor Exhibition
- ✓ Conference Social Event
- ✓ Meals (if needed)

What are the requirements?

- The student must be a member (or willing to join) of IEEE and IAS.
- The student's mentor from the Mill (or another co-worker) must attend with them.
- IEEE/IAS will reimburse either the student or company for the documented travel costs of airfare, other transportation, and meals <u>up to a maximum</u> of \$2000 per student.
- Reimbursement will take place after the completion of the conference.
- The student must attend one sub-committee meeting and the general committee meeting
- Preference will be given to students working for a Mill
- The student's employer must be willing to pay them their normal salary while they are at the Conference (we don't want them to have to take time off to attend)
- Only 1 student per Mill site.

A few highlights from the Conference:

- We begin with the Welcome Reception at the hotel on Sunday Night.
- Some great technical papers and very interesting tutorials will be presented during the Conference on Thursday (& sometimes Friday).
- Many vendor booths will be available to visit throughout the conference.
- The Wednesday Conference Awards Dinner & Closing Event is a fun event to finish the Conference.
- The PPIC Subcommittee meetings are on Tuesday from 12:00pm until 5pm. The subcommittees are where the papers, tutorials, and other topics are generated for upcoming conferences.





We have four subcommittees consisting of:

DCS Drives and Control Systems

PCEMC Process Control, Engineering, Maintenance and Construction

PDS Power Distribution Systems

S&T Safety and Training

We also have a Standards Committee, which is currently developing a Recommended Practice for Specifying AC Coordinated Adjustable Speed Drive Systems for Operation on 3 Phase AC 50/60 Hertz up to 1000 Volts for Pulp and Paper Industry Installations

Visit www.pulppaper.org for more information on the Conference!

Please fill out the following:

Name	
IEEE Member number, if	
already a member	
Active email address	
Phone number	
Company	
Company Location	
(Mailing Address)	
College Name and Location	
Degree and level complete	
as of June before the	
Conference	
Anticipated Graduation Date	
Name and Title of Mentor	
Attending Conference	
Subcommittee Preference	

If you are not currently a member of IEEE and the IAS, you will be required to sign up for IEEE before attending the conference and will be reimbursed after the conference. The IAS application will be completed at the conference.

Please return this application by MAY 10 via e-mail, and direct any questions to:

Emily Held emily.held@ipaper.com 541-731-0432